

PATENT NUMBER and **ISSUE DATE**

U.S. UTILITY Patent Application

	APPL NUM 10002175	FILING DATE 12/05/2001	CLASS 228	SUBCLASS		EXAMINER Edmondson	
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	**CONTINUING	G DATA VERIFIED): - L A 1				
	** FOREIGN AF	PPLICATIONS VE	RIFIED:	-CRE			
1 5		OT PUBLISH 🗖		RESCIN	D 🗖		
11:	Foreign priority clain 35 USC 119 condition Verified and Acknow		□ yes □ yes tials			ATTORNEY DOCKET N M4065.0493/P493	10
<u> </u>	TTLE : Stacked	chip connection u	sing stan	d off stitch bon	ding	U.S.DEPT. OF COMM./PAT.& TM-PTC	D-436L(Rev. 12-94)

PG-PUB DO NOT PUBLISH	RESCIND						
Foreign priority claimed 35 USC 119 conditions met Verified and Acknowledged Examiners's	□ yes □ no □ yes □ no intials		ATTORNEY DOCKET NO M4065.0493/P493				
TITLE: Stacked chip connection using stand off stitch bonding U.S.DEPT. OF COMM./PAT.& TM-PTO-436L(Rev. 12-94)							
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	Assistant Examiner		Total Claims	0.0	Claim for		
ISSUE FEE Dunt Due Date Paid			Sheets Drveg.	DRAWING Figs.Drwg.	Print Fig.		
	Primary Examine PREPARED FOR ISSUE		Application Examiner				

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